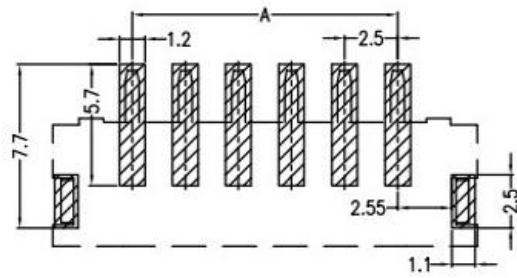
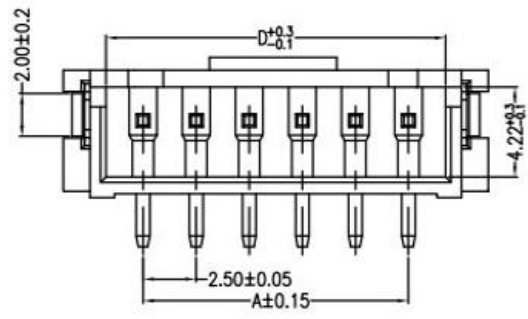


Assembly Layout

Main Specifications

- Contact resistance : $\leq 20m\Omega$
- Insulation resistance : $\geq 1000M\Omega$
- Rated voltage : 250V AC DC
- Rated current : 3.0A AC DC
- Withstand Voltage : 1000V AC/minute
- Temperature Range : $-25^{\circ}C \sim +85^{\circ}C$



SUGGESTED PCB LAYOUT

| Circuit | Dimensions (mm) | | | | Circuit | Dimensions (mm) | | | |
|---------|-----------------|-------|-------|-------|---------|-----------------|-------|-------|-------|
| | A | B | C | D | | A | B | C | D |
| 02 | 2.50 | 7.50 | 10.00 | 6.00 | 10 | 22.50 | 27.50 | 30.00 | 26.00 |
| 03 | 5.00 | 10.00 | 12.50 | 8.50 | 11 | 25.00 | 30.00 | 32.50 | 28.50 |
| 04 | 7.50 | 12.50 | 15.00 | 11.00 | 12 | 27.50 | 32.50 | 35.00 | 31.00 |
| 05 | 10.00 | 15.00 | 17.50 | 13.50 | 13 | 30.00 | 35.00 | 37.50 | 33.50 |
| 06 | 12.50 | 17.50 | 20.00 | 16.00 | 14 | 32.50 | 37.50 | 40.00 | 36.00 |
| 07 | 15.00 | 20.00 | 22.50 | 18.50 | 15 | 35.00 | 40.00 | 42.50 | 38.50 |
| 08 | 17.50 | 22.50 | 25.00 | 21.00 | 16 | 37.50 | 42.50 | 45.00 | 41.00 |
| 09 | 20.00 | 25.00 | 27.50 | 23.50 | | | | | |

科斯达电子科技有限公司

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|--|---------------------------|----------------------------------|
| 檢驗尺寸標示 SYMBOLS ① ② INDICATE CLASSIFICATION DIMENSION ① MARK IS CRITICAL DIM. ② MARK IS MAJOR DIM. | 工程圖號 XHB25LB-nP | 制圖 (DR) *12/5/16 審核 (CHKD) |
| 品名 XHB2.5mm - nP 立貼帶扣 | 比例 (SCALE) 1:1 | 單位 (UNITS) mm |
| TITLE XHB2.5mm Pitch LB FOR SMT CONN | 表面處理 (FINISH) | 核准 (APPD) Rigo Lu |
| 表面處理 (FINISH) | 日期 (DATE) | 簽名 (SIGNATURE) |
| 修改摘要 REVISION DESCRIPTION | 日期 DATE | 簽名 SIGNATURE |
| 張數 (SHEET) 1 OF 1 | 尺寸 (SIZE) A4 | 版本 (REV) 0 |

| | | | |
|-----|------------------------------|------------|-----------------|
| △ | - | - | - |
| REV | 修改摘要 REVISION DESCRIPTION | 日期 DATE | 簽名 SIGNATURE |